

S-5842A Series

DUAL TRIP TEMPERATURE SWITCH IC (THERMOSTAT IC)

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Rev.2.3 02

The S-5842A Series is a dual trip temperature switch IC (thermostat IC) which detects two points of temperature. The S-5842A Series operates at the power supply voltage of 2.5 V and the lower current consumption of 10 μ A typ. A temperature sensor with the negative temperature coefficient, a reference voltage generation circuit, a comparator and a delay circuit are integrated on one chip, and enclosed into the packages SOT-23-6 and SNT-6A.

■ Features

• Detection temperature: Detection temperature = -10° C to $+110^{\circ}$ C, $+1^{\circ}$ C step

• Accuracy of detection temperature: $\pm 2.5^{\circ}$ C (Only for either detection temperature)

• Low voltage operation: $V_{DD} = 2.5 \text{ V min.}$ (Detection temperature = +20°C to +110°C)

 V_{DD} = 2.7 V min. (Detection temperature = 0°C to +110°C)

 V_{DD} = 2.8 V min. (Detection temperature = -10°C to +110°C)

• Low current consumption: $I_{DD} = 10 \mu A \text{ typ.}$ (Ta = $\pm 25^{\circ}\text{C}$)

Selectable output form: CMOS output, Nch open-drain output

Selectable output type: Separate, Integrate

Selectable output logic: "H", "L"

Operation temperature range:
 Ta = -40°C to +125°C

Lead-free, Sn 100%, halogen-free*1

*1. Refer to "■ Product Name Structure" for details.

■ Applications

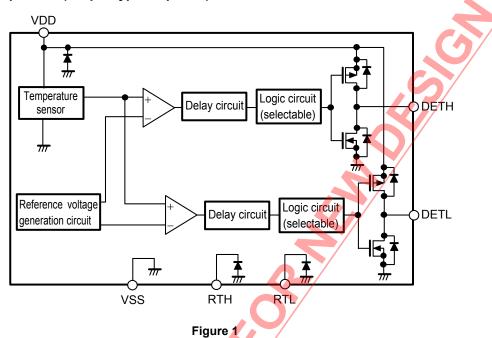
- Fan control
- · Air-conditioning system
- Mobile phone
- Game console
- Various electronics devices

■ Packages

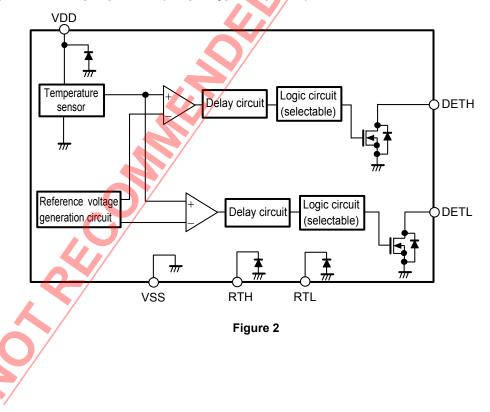
- SOT-23-6
- SNT-6A

■ Block Diagrams

1. CMOS output product (Output type: Separate)

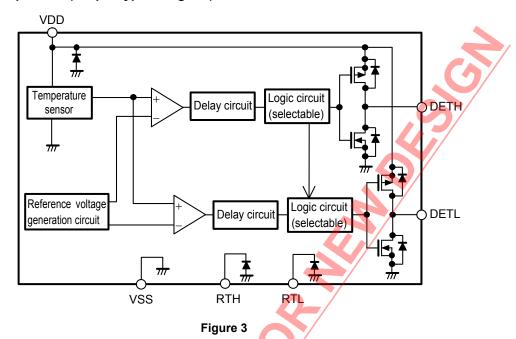


2. Nch open-drain output product (Output type: Separate)

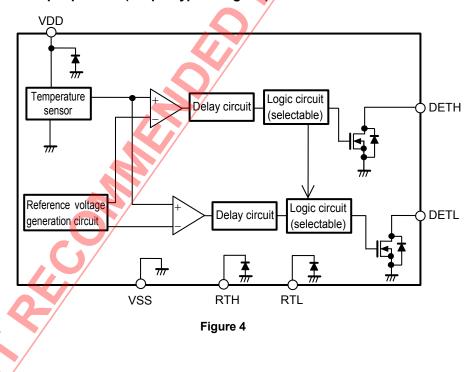


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3. CMOS output product (Output type: Integrate)



4. Nch open-drain output product (Output type: Integrate)

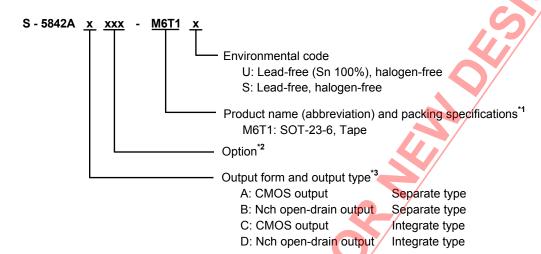


■ Product Name Structure

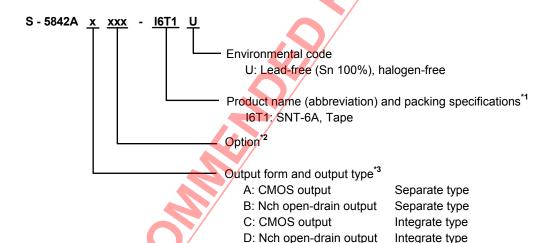
Users are able to select the output form and type, option for detection temperature's spec and package for the S-5842A Series.

1. Product name

1.1 SOT-23-6



1.2 SNT-6A



- *1. Refer to the tape drawing.
- *2. Refer to "■ Selection of Product Option". Settings are available in alphabetical order as AAA to ZZZ.
- *3. Refer to "■ Selection of Product Option".

2. Packages

Table 1 Package Drawing Codes

Package Name	ckage Name Dimension		Reel	Land
SOT-23-6	MP006-A-P-SD	MP006-A-C-SD	MP006-A-R-SD	_
SNT-6A	PG006-A-P-SD	PG006-A-C-SD	PG006-A-R-SD	PG006-A-L-SD

3. Product name list

3.1 SOT-23-6

Table 2

		•								
		Option for Detection Temperature's Spec								
		DETH	Pin (for Hig	her Tempera	ture)	DETL	Pin (for Lov	er Temperat	ure)	
Product Name	Output Form and Type	Detection Temperature (T _{DH})	Accuracy of Detection Temperature*1	Hysteresis Temperature (T _{HYSH})	Output Logic	Detection Temperature (T _{DL})	Accuracy of Detection Temperature*1	Hysteresis Temperature (T _{HYSL})	Output Logic	
S-5842AAAAF-M6T1y	CMOS, Separate	+95°C	_	−5°C	"L"	+55°C	±2.5°C	−5°C	"L"	
S-5842AAAAG-M6T1y	CMOS, Separate	+60°C	_	−5°C	"H"	0°C	±2.5°C	+5°C	"L"	
S-5842AAAAL-M6T1U	CMOS, Separate	+45°C	±2.5°C	-2°C	"H"	0°C	_	+2°C	"H"	
S-5842AAAAN-M6T1y	CMOS, Separate	+50°C	_	−5°C	-	+40°C	±2.5°C	−5°C	"L"	
S-5842ACAAM-M6T1y	CMOS, Integrate	+45°C	_	-2°C	? "L"/	0°C	±2.5°C	-2°C	"L"	

^{*1} Either of two detection temperatures (T_{DH}, T_{DL}), an accuracy of ±2.5°C is set only for the one that user specifies a higher accuracy than the other (T_{DH}, T_{DL}).

Remark 1. Please contact our sales office for products other than those specified above. Refer to "■ Selection of Product Option" for details.

- 2. y: S or U
- 3. Please select products of environmental code = U for Sn 100%, halogen-free products.



3.2 SNT-6A

Table 3

				Option for I	Detection	Temperati	ıre's Spec		
	Ott. F	DETH Pin (for Higher Temperature)				DETL Pin (for Lower Temperature)			
Product Name	Output Form and Type	Detection Temperature (T _{DH})	Accuracy of Detection Temperature*1	Hysteresis Temperature (T _{HYSH})	Output Logic	Detection Temperature (T _{DL})	Accuracy of Detection Temperature*1	Hysteresis Temperature (T _{HYSL})	Output Logic
S-5842AAAAL-I6T1U	CMOS, Separate	+45°C	±2.5°C	–2°C	"H"	0°C	\- /	+2°C	"H"
S-5842AAAAT-I6T1U	CMOS, Separate	+45°C	-	–2°C	"H"	0°C	±2.5°C	+2°C	"L"
S-5842ABAAA-I6T1U	Nch open-drain, Separate	+62°C	-	+2°C	"H"	-3°C	±2.5°C	–2°C	"L"
S-5842ABAAC-I6T1U	Nch open-drain, Separate	+60°C	-	–2°C	"H"	0°C	±2.5°C	+2°C	"L"
S-5842ABAAJ-I6T1U	Nch open-drain, Separate	+40°C	-	–2°C	"H"	+5°C	±2.5°C	+2°C	"L"
S-5842ABAAP-I6T1U	Nch open-drain, Separate	+70°C	-	–5°C	"L"	+50°C	±2.5°C	−5°C	"H"
S-5842ABAAV-I6T1U	Nch open-drain, Separate	+65°C	-	– 5 °C	"L"	+50°C	±2.5°C	−5°C	"L"
S-5842ABAAW-I6T1U	Nch open-drain, Separate	+62°C	_	-2°C	"H"	+2°C	±2.5°C	-2°C	"H"
S-5842ABAAX-I6T1U	Nch open-drain, Separate	+55°C	-//	-5°C	"H"	−10°C	±2.5°C	+5°C	"L"
S-5842ACAAS-I6T1U	CMOS, Integrate	+45°C		–2°C	"L"	0°C	±2.5°C	+2°C	"L"
S-5842ADAAH-I6T1U	Nch open-drain, Integrate	+70°C	±2.5°C	–5°C	"L"	+5°C	-	−5°C	"H"
S-5842ADAAK-I6T1U	Nch open-drain, Integrate	+60°C	±2.5°C	−5°C	"L"	+5°C	-	−5°C	"H"
S-5842ADAAQ-I6T1U	Nch open-drain, Integrate	+60°C	_	–2°C	"H"	0°C	±2.5°C	+2°C	"L"

^{*1} Either of two detection temperatures (T_{DH} , T_{DL}), an accuracy of $\pm 2.5^{\circ}$ C is set only for the one that user specifies a higher accuracy than the other (T_{DH} , T_{DL}).

Remark Please contact our sales office for products other than those specified above. Refer to "■ Selection of Product Option" for details.

■ Pin Configurations

1. SOT-23-6

Top view
6 5 4
H H H
H H
1 2 3

Figure 5

Table 4

Pin No.	Symbol	Description
1	VDD	Power supply pin
2	DETL	Output pin for lower temperature detection
3	RTL*1	TEST pin
4	RTH ^{*2}	TEST pin
5	VSS	GND pin
6	DETH	Output pin for higher temperature detection

- *1. Set the RTL pin open in use.
- *2. Set the RTH pin open in use.

2. SNT-6A

Table

	ı op v	iew		
1 2 3	0];	6 5 4	

Figure 6

Pin No.	Symbol	Description
1	DETH	Output pin for higher temperature detection
2	VSS	GND pin
3	RTH*1	TEST pin
4	RTL*2	T EST pin
5	DETL	Output pin for lower temperature detection
6	VDD //	Power supply pin

- *1. Set the RTH pin open in use.
- *2. Set the RTL pin open in use.

■ Absolute Maximum Ratings

Table 6

(Ta = +25°C unless otherwise specified)

			(1d 120 C diffices cure) whee	0,000,000,
Item		Symbol	Absolute Maximum Rating	Unit
Power supply vo	oltage (V _{SS} = 0 V)	V_{DD}	V _{SS} + 6.5	V
Pin voltage		V_{RTH}, V_{RTL}	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Output valtage	CMOS output product	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Output voltage	Nch open-drain output product	V_{DETH}, V_{DETL}	$V_{SS} - 0.3$ to $V_{SS} + 6.5$	V
Output pip ourre			13	mA
Output pin curre	ent.	I _{OLH} , I _{OLL}	13	mA
Power	SOT-23-6	Б	650 ^{*1}	mW
dissipation SNT-6A		P _D	400*1	mW
Operation ambient temperature		T _{opr}	-40 to +125	°C
Storage tempera	ature	T _{stg}	−65 to +150	°C

^{*1.} When mounted on board

[Mounted board]

(1) Board size : $114.3 \text{ mm} \times 76.2 \text{ mm} \times t1.6 \text{ mm}$ (2) Board name : JEDEC STANDARD51-7

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.



■ DC Electrical Characteristics

1. CMOS output product

Table 7

(Ta = +25°C unless otherwise specified)

				(1a - 120	C unless our	OI WISC S	pecinea,
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
		Detection temperature = +20°C to +110°C	2.5	-	5.5	V	1
Power supply voltage	V_{DD}	Detection temperature = 0°C to +110°C	2.7	-	5.5	٧	1
		Detection temperature = -10°C to +110°C	2.8		5.5	٧	1
Detection temperature*1	T _{DH} or T _{DL}	_	T _{DET} – 2.5	T _{DET}	T _{DET} + 2.5	°C	1
Difference of detection temperature*2	ΔT_D	V _{DD} = 3.5 V	-	ΔT_{DET}	-	°C	1
Hysteresis temperature of DETH pin*3	T _{HYSH}	V _{DD} = 3.5 V	-	-5, −2, +2, +5	-	°C	1
Hysteresis temperature of DETL pin*3	T _{HYSL}	V _{DD} = 3.5 V	A -/	−5, −2, +2, +5	-	°C	1
Output current "H" of DETH pin	Іонн	V _{DD} = 3.5 V, V _{DETH} = 3.0 V	0.5	3.2	-	mA	2
Output current "H" of DETL pin	I _{OHL}	$V_{DD} = 3.5 \text{ V}, V_{DETL} = 3.0 \text{ V}$	0.5	3.2	ı	mA	2
Output current "L" of DETH pin	I _{OLH}	$V_{DD} = 3.5 \text{ V}, V_{DETH} = 0.5 \text{ V}$	0.5	3.0	-	mA	2
Output current "L" of DETL pin	I _{OLL}	$V_{DD} = 3.5 \text{ V}, V_{DETL} = 0.5 \text{ V}$	0.5	3.0	-	mA	2
Current consumption during operation	I _{DD}	V _{DD} = 3.5 V	-	10	16	μΑ	1

^{*1.} T_{DET}: set value for detection temperature, T_{DH}: actual detection temperature for higher temperature,

T_{DL}: actual detection temperature for lower temperature

Either of two detection temperatures (T_{DH} , T_{DL}), an accuracy of ± 2.5 °C is set only for the one that user specifies a higher accuracy than the other (T_{DH} , T_{DL}).

*2. ΔT_{DET} : set value for detection temperature for higher temperature – set value for detection temperature for lower temperature

ΔT_D: actual difference of detection temperature

Set two points of detection temperature so that the difference of detection temperature (ΔT_{DET}) is in 0°C to 65°C. Users are able to set ΔT_{DET} in 0°C, 5°C, 10°C ... 60°C, 65°C.

*3. Users are able to select the hysteresis temperature in -5°C, -2°C, +2°C, or +5°C.

[Fahrenheit ⇔ Celsius Conversion equation]

 $^{\circ}$ C = ($^{\circ}$ F - 32) × 5/9

 $^{\circ}F = 32 + ^{\circ}C \times 9 / 5$

2. Nch open-drain output product

Table 8

(Ta = $+25^{\circ}$ C unless otherwise specified)

				(13.	C unicas ouic		
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
		Detection temperature = +20°C to +110°C	2.5	-	5.5	V	1
Power supply voltage	V_{DD}	Detection temperature = 0°C to +110°C	2.7	-	5.5	٧	1
		Detection temperature = -10°C to +110°C	2.8	-	5.5	٧	1
Detection temperature*1	T _{DH} or T _{DL}	_	T _{DET} – 2.5	T _{DET}	T _{DET} + 2.5	°C	1
Difference of detection temperature*2	ΔT_D	V _{DD} = 3.5 V	-	ΔT_{DET}	_	°C	1
Hysteresis temperature of DETH pin ^{*3}	T _{HYSH}	V _{DD} = 3.5 V	-	-5, -2, +2, +5	ı	ů	1
Hysteresis temperature of DETL pin*3	T _{HYSL}	V _{DD} = 3.5 V	-	-5, -2, +2, +5	1	°C	1
Leakage current of DETH pin	I _{LEAKH}	$V_{DD} = 3.5 \text{ V}, V_{DETH} = 5.5 \text{ V}$		_	100	nA	2
Leakage current of DETL pin	I _{LEAKL}	$V_{DD} = 3.5 \text{ V}, V_{DETL} = 5.5 \text{ V}$		_	100	nA	2
Output current "L" of DETH pin	I _{OLH}	$V_{DD} = 3.5 \text{ V}, V_{DETH} = 0.5 \text{ V}$	0.5	3.0	_	mA	2
Output current "L" of DETL pin	I _{OLL}	$V_{DD} = 3.5 \text{ V}, V_{DETL} = 0.5 \text{ V}$	0.5	3.0	_	mA	2
Current consumption during operation	I _{DD}	V _{DD} = 3.5 V	_	10	16	μΑ	1

^{*1.} T_{DET}: set value for detection temperature, T_{DH}: actual detection temperature for higher temperature,

T_{DL}: actual detection temperature for lower temperature

Either of two detection temperatures (T_{DH} , T_{DL}), an accuracy of ± 2.5 °C is set only for the one that user specifies a higher accuracy than the other (T_{DH} , T_{DL}).

*2. ΔT_{DET} : set value for detection temperature for higher temperature – set value for detection temperature for lower temperature

ΔT_D: actual difference of detection temperature

Set two points of detection temperature so that the difference of detection temperature (ΔT_{DET}) is in 0°C to 65°C. Users are able to set ΔT_{DET} in 0°C, 5°C, 10°C ... 60°C, 65°C.

*3. Users are able to select the hysteresis temperature in -5°C, -2°C, +2°C, or +5°C.

[Fahrenheit ⇔ Celsius Conversion equation]

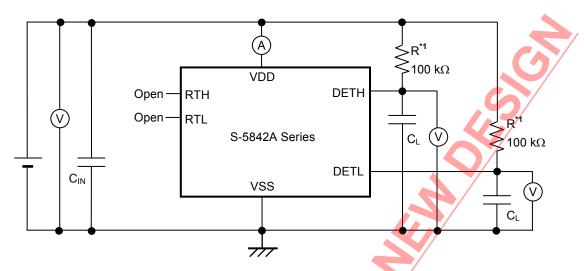
$$^{\circ}$$
C = ($^{\circ}$ F - 32) × 5 / 9
 $^{\circ}$ F = 32 + $^{\circ}$ C × 9 / 5

■ AC Electrical Characteristics

Table 9

ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Noise suppression time	e t _{delay}	V_{DD} = 3.5 V, Ta = detection temperature	-	550	-	μS	-

■ Test Circuits



*1. Resistor (R) is unnecessary for the CMOS output product.

Figure 7 Test Circuit 1

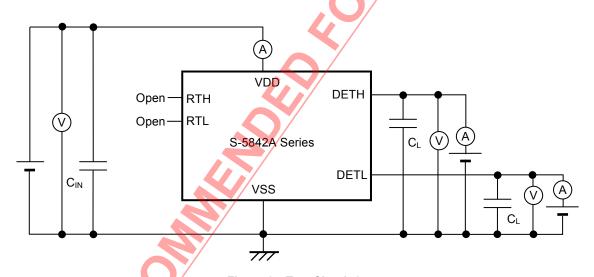


Figure 8 Test Circuit 2

■ Selection of Product Option

1. Description of product option

The S-5842A Series is a temperature switch IC (thermostat IC) which detects two points of temperature, and outputs a signal to the exterior.

Users are able to select the combination of output type, form and logic, two detection temperatures (T_{DH} , T_{DL}), and hysteresis temperature (T_{HYSH} , T_{HYSL}).

Output form: Set the output logic for each DETH pin and DETL pin.

- CMOS output
- Nch open-drain output

Output type: for DETH pin and DETL pin, users are able to select two types of output as follows.

- Separate type: The DETH pin's output inverts during detection of higher temperature
 The DETL pin's output inverts during detection of lower temperature
- Integrate type: The DETH pin's output inverts during detection of higher temperature
 The DETL pin's output inverts during detection of higher and lower temperature

Detection temperature (T_{DH}, T_{DL}):

 T_{DH} is the detection temperature for higher temperature, T_{DL} is the detection temperature for lower temperature. Of two points of detection temperatures (T_{DH} , T_{DL}), select the detection temperature that is to be set the higher accuracy ($\pm 2.5^{\circ}$ C accuracy).

- The detection temperature for higher temperature is selectable in +20°C to +110°C, in 1°C step.
- The detection temperature for lower temperature is selectable in -10°C to +110°C, in 1°C step.
- Set two points of detection temperature so that the difference of detection temperature (ΔT_{DET}) is in 0°C to 65°C. Users are able to set ΔT_{DET} in 0°C, 5°C, 10°C ... 60°C, 65°C.

The minimum operation voltage varies according to the detection temperature for lower temperature.

Detection temperature = +20°C to +110°C: V_{DD} = 2.5 V min.
 Detection temperature = 0°C to +110°C: V_{DD} = 2.7 V min.
 Detection temperature = -10°C to +110°C: V_{DD} = 2.8 V min.

*1 Either of two detection temperatures (T_{DH}, T_{DL}), an accuracy of ±2.5°C is set only for the one that user specifies a higher accuracy than the other (T_{DH}, T_{DL}).

Hysteresis temperature (T_{HYSH}, T_{HYSL}):

 T_{HYSH} is the hysteresis temperature for detection temperature for higher temperature, T_{HYSL} is the hysteresis temperature for detection temperature for lower temperature. These are selectable in -5° C, -2° C, $+2^{\circ}$ C, or $+5^{\circ}$ C.

- -5°C: Output recovers when temperature has dropped to 5°C from the detection temperature.
- -2°C: Output recovers when temperature has dropped to 2°C from the detection temperature.
- +2°C; Output recovers when temperature has risen to 2°C from the detection temperature.
- +5°C: Output recovers when temperature has risen to 5°C from the detection temperature.

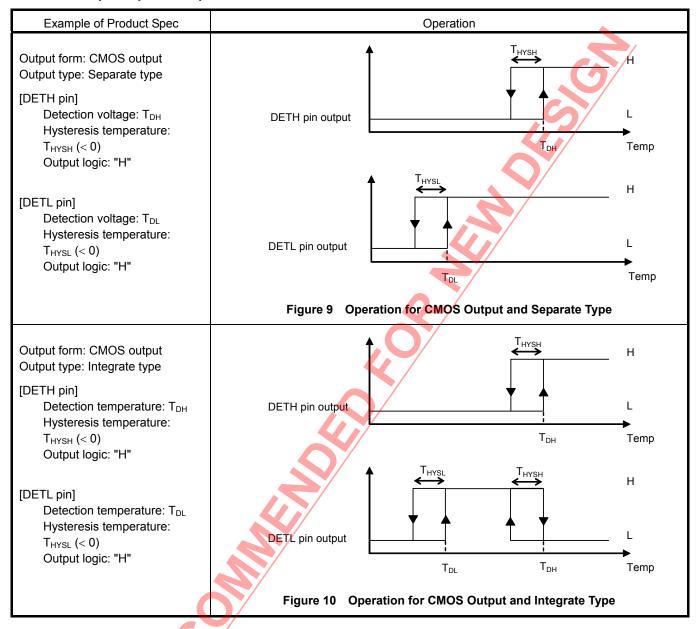
Output logic:

Set the output logic for each DETH, DETL pin in Ta > detection temperature (T_{DH} , T_{DL}) or release temperature ($T_{DH} + T_{HYSH}$, $T_{DL} + T_{HYSL}$).

- Hysteresis temperature: –5°C, –2°C
 - The output logic is "H" in Ta > detection temperature
 - The output logic is "L" in Ta > detection temperature
- (2) Hysteresis temperature: +2°C, +5°C
 - The output logic is "H" in Ta > release temperature
 - The output logic is "L" in Ta > release temperature

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2. Example of product spec



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Operation

1. Separate type

The followings are the operation with its specs when the S-5842A Series is Separate type. The timing chart is shown in Figure 11.

Output form and type: CMOS output, Separate type
 Output
 DETH pin
 Detection tom

• Option : DETH pin Detection temperature $T_{DH} = +95^{\circ}C$

Hysteresis temperature $T_{HYSH} = -5^{\circ}C$

Output logic

DETL pin Detection temperature

Hysteresis temperature

Output logic

"H" T_{DL} = +55°C

 $T_{HYSL} = -5^{\circ}C$

"H"

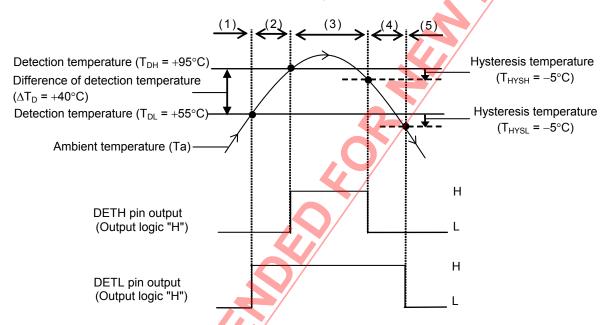


Figure 11 Timing Chart for CMOS Output and Separate Type

Detecting the temperature is started after power-on.

In case;

- (1) Ambient temperature (Ta) < detection temperature ($T_{DL} = +55^{\circ}C$) The DETH pin output and the DETL pin output keep "L".
- (2) The ambient temperature (Ta) rises; detection temperature (T_{DL} = +55°C) < ambient temperature (Ta) < detection temperature (T_{DH} = +95°C) The DETH pin output keeps "L", the DETL pin output gets "H".
- (3) Furthermore, the ambient temperature (Ta) rises; ambient temperature (Ta) > detection temperature (T_{DH} = +95°C) The DETL pin output keeps "H", the DETH pin output gets "H".
- (4) After that, the ambient temperature (Ta) falls; release temperature (T_{DH} + T_{HYSH} = +90°C) > ambient temperature (Ta) > release temperature (T_{DL} + T_{HYSL} = +50°C) The DETH pin output gets "L", the DETL pin output keeps "H".
- (5) Furthermore the ambient temperature (Ta) falls; ambient temperature (Ta) < release temperature (T_{DL} + T_{HYSL} = +50°C) The DETH pin output keeps "L", the DETL pin output gets "L".

2. Integrate type

The followings are the operation with its specs when the S-5842A Series is Separate type. The timing chart is shown in **Figure 12**.

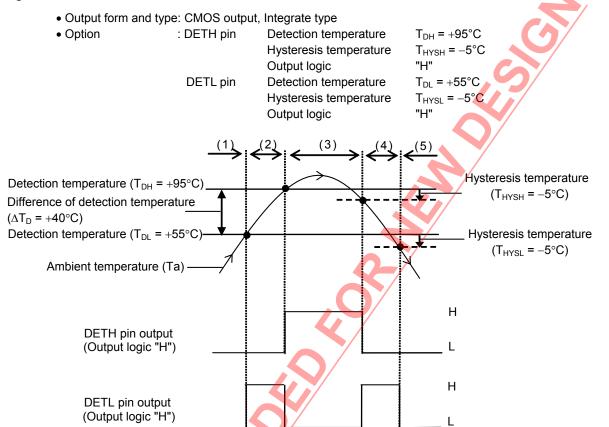


Figure 12 Timing Chart for CMOS Output and Integrate Type

Detecting the temperature is started after power-on.

In case;

- (1) Ambient temperature (Ta) < detection temperature ($T_{DL} = +55^{\circ}C$) The DETH pin output and the DETL pin output keep "L".
- (2) The ambient temperature (Ta) rises; detection temperature (T_{DL} = +55°C) < ambient temperature (Ta) < detection temperature (T_{DH} = +95°C) The DETH pin output keeps "L", the DETL pin output gets "H".
- (3) Furthermore, the ambient temperature (Ta) rises; ambient temperature (Ta) > detection temperature (T_{DH} = +95°C) The DETH pin output gets "H", the DETL pin output gets "L".
- (4) After that, the ambient temperature (Ta) falls; release temperature (T_{DH} + T_{HYSH} = +90°C) > ambient temperature (Ta) > release temperature (T_{DL} + T_{HYSL} = +50°C) The DETH pin output gets "L", the DETL pin output gets "H".
- (5) Furthermore the ambient temperature (Ta) falls; ambient temperature (Ta) < release temperature (T_{DL} + T_{HYSL} = +50°C) The DETH pin output keeps "L", the DETL pin output gets "L".

3. Delay circuit

The S-5842A Series sets the noise suppression time (t_{delay}) via the delay circuit. By this, the S-5842A Series prevents false detection operations of DETH pin and DETL pin output.

The followings are the operation of the DETH pin output when the output logic is "H".

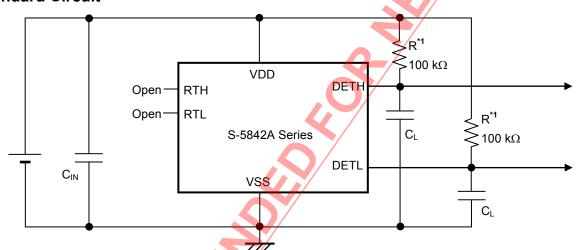
3. 1 The temperature is the detection temperature or less

The output from a comparator is "H", and the DETH pin output is "L". Due to noise or others, the output from a comparator is inverted to "L" once; however, the DETH pin output keeps "L" if this status is t_{delay} or shorter.

3. 2 The temperature exceeds the detection temperature

The output from a comparator gets "L". And the DETH pin output gets "H" after the period has passed t_{delay} or longer.

■ Standard Circuit



*1. Resistor (R) is unnecessary for CMOS output product.

Figure 13

Caution The above connection diagram will not guarantee successful operation. Perform thorough evaluation using actual application to set the constant.

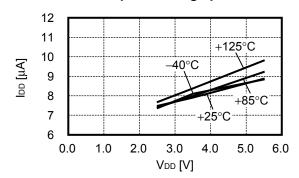
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■ Precautions

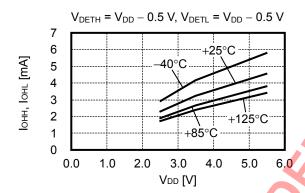
- Either of two detection temperatures (T_{DH}, T_{DL}), an accuracy of ±2.5°C is set only for the one that user specifies a
 higher accuracy than the other (T_{DH}, T_{DL}).
- Set a capacitor (C_{IN}) of 0.1 μF or more between the VDD pin and VSS pin for stabilization.
- To prevent error due to noise during power-on, set a capacitor (C_L) of approx. 0.1 μF for the DETH pin and the DETL pin.
- The S-5842A Series may oscillate by connecting a capacitor to the RTH pin and the RTL pin. Set the RTH pin and the RTL pin open in use.
- The DETH / DETL pin output a signal that of (Ta > detection temperature) by short-circuit the RTH / RTL pin to VSS.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic
 protection circuit.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products, including this IC, of patents owned by a third party.

■ Characteristics (Typical Data)

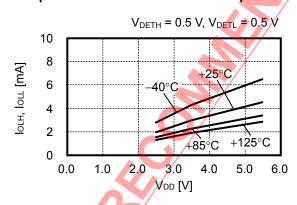
1. Current consumption during operation vs. Power supply voltage characteristics



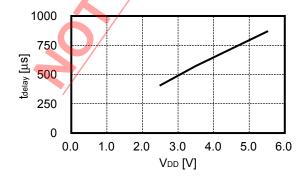
2. Output current "H" of DETH / DETL pin vs. Power supply voltage characteristics (CMOS output product only)



3. Output current "L" of DETH / DETL pin vs. Power supply voltage characteristics

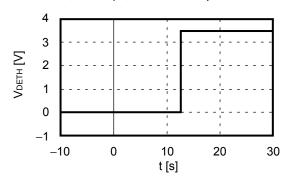


4. Noise suppression time vs. Power supply voltage characteristics



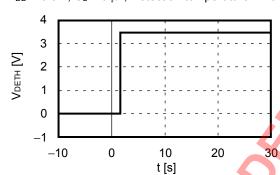
- 5. Response against heat (Output voltage vs. Time)
 - 5. 1 When SNT-6A is put into the air of $+100^{\circ}$ C from the air of $+25^{\circ}$ C at t = 0 s

 V_{DD} = 3.5 V, C_L = 0 μ F, Detection temperature = +62°C, Output logic "H"



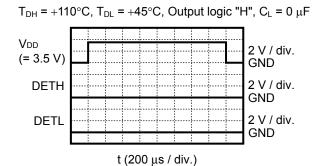
5. 2 When SNT-6A is put into the liquid of $+100^{\circ}$ C from the air of $+25^{\circ}$ C at t=0 s

 V_{DD} = 3.5 V, C_L = 0 μ F, Detection temperature = +62°C, Output logic "H"

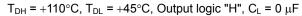


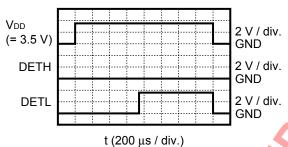
6. Response against startup

6. 1 Power-on at Ta = +25°C



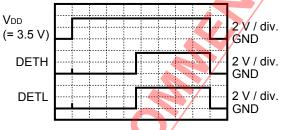
6. 2 Power-on at Ta = +80°C





6. 3 Power-on at Ta = +120°C

$$T_{DH}$$
 = +110°C, T_{DL} = +45°C, Output logic "H", C_L = 0 μ F



t (200 μs / div.)

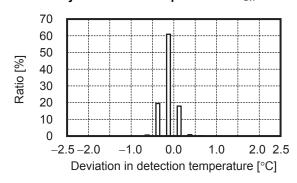
7. Accuracy of detection temperature

High accuracy detection voltage: T_{DH}

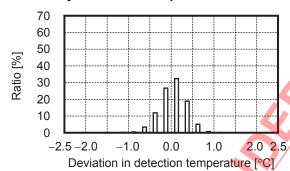
$$T_{DH} = +110^{\circ}C, T_{DL} = +45^{\circ}C$$

Measured data on one wafer picked up

7. 1 Accuracy of detection temperature at $T_{DH} = +110$ °C (Higher accuracy)

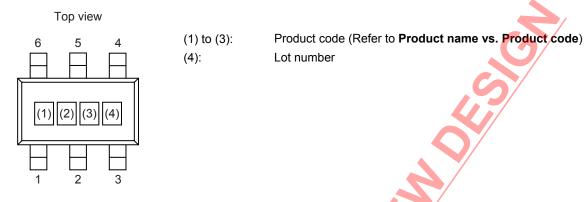


7. 2 Accuracy of detection temperature at $T_{DL} = +45$ °C



■ Marking Specifications

1. SOT-23-6



Product name vs. Product code

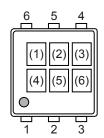
5	Product Code				
Product Name	(1)	(2)	(3)		
S-5842AAAAF-M6T1y	U	I	F		
S-5842AAAAG-M6T1y	U	I	G		
S-5842AAAAL-M6T1U	U	I	L		
S-5842AAAAN-M6T1y	U	I	N		
S-5842ACAAM-M6T1y	U	J	М		

Remark 1. y: S or U

2. Please select products of environmental code = U for Sn 100%, halogen-free products.

2. SNT-6A

Top view



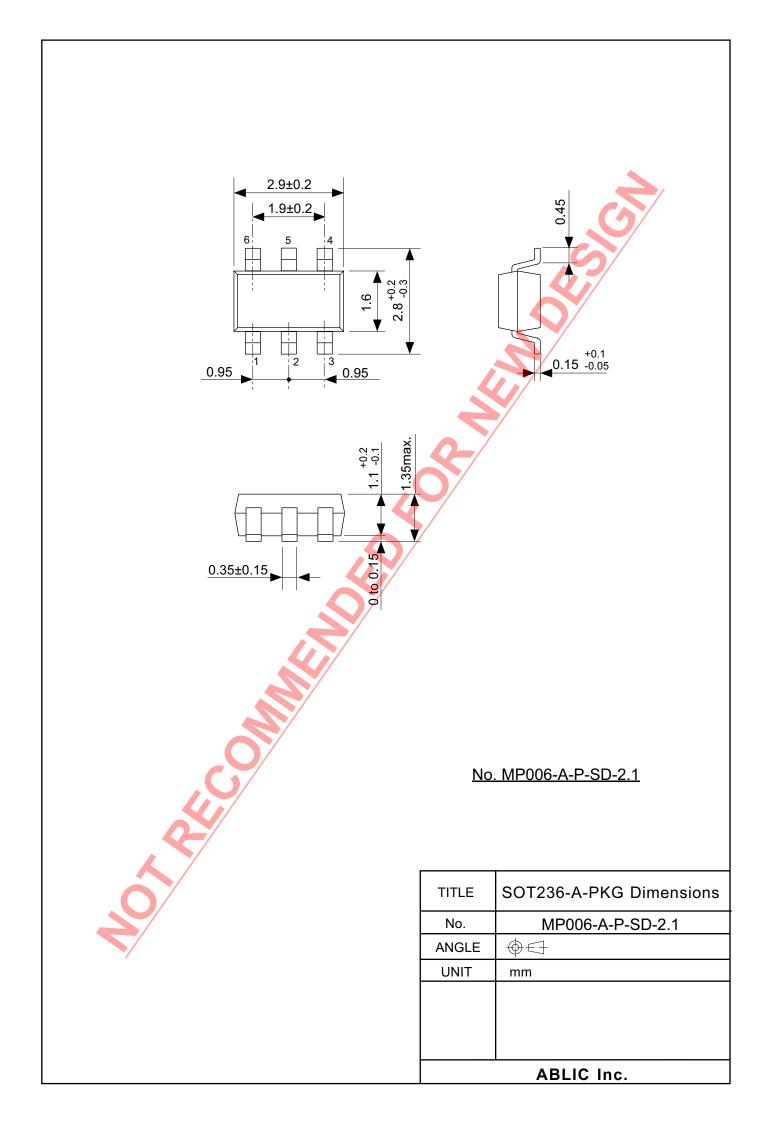
(1) to (3): Product code (Refer to **Product name vs. Product code**)

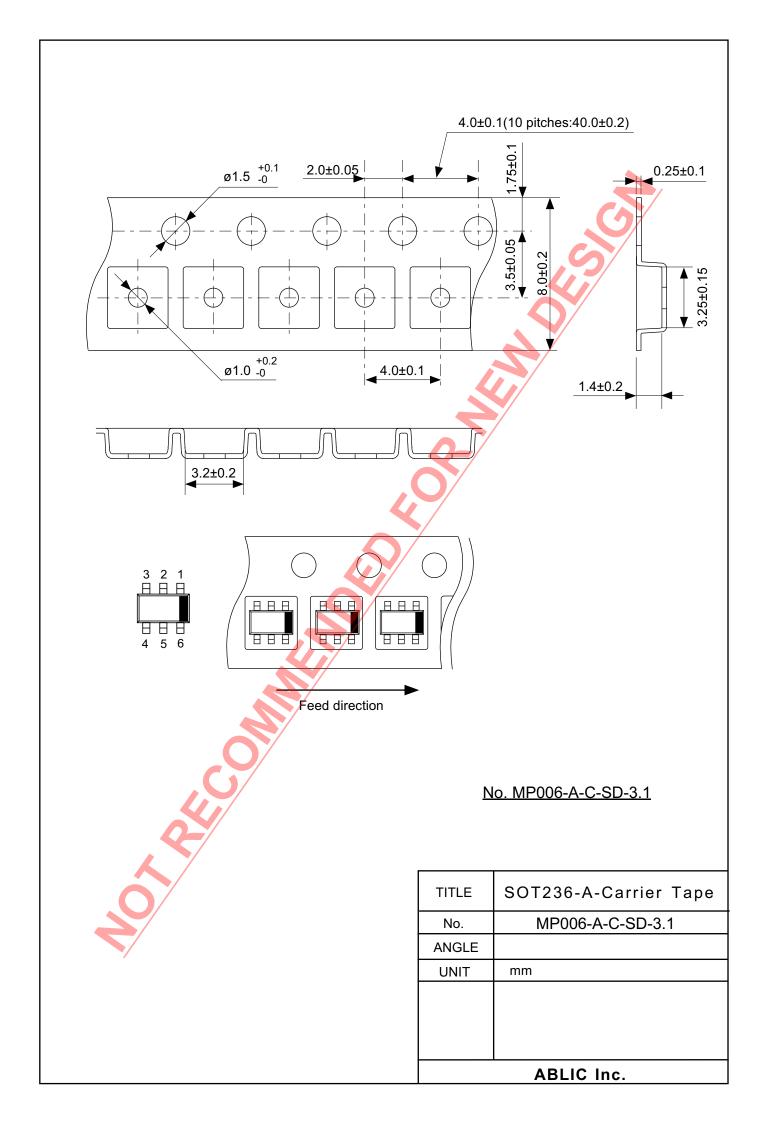
Lot number

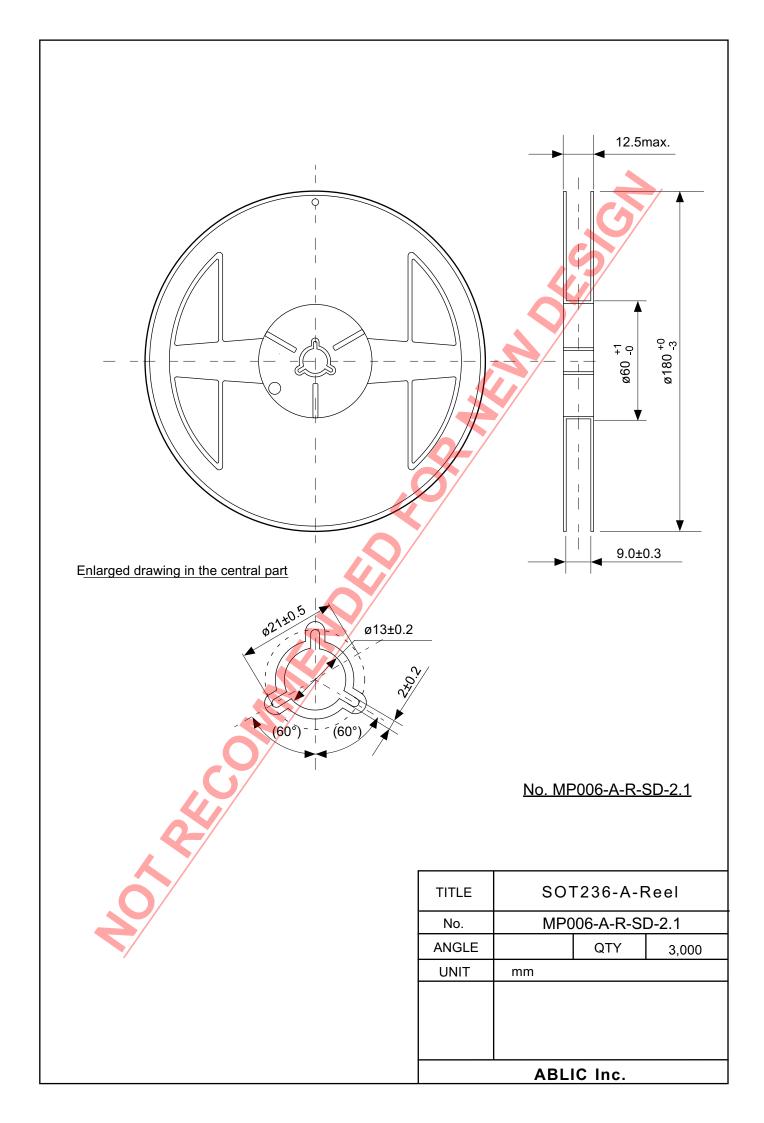
(4) to (6):

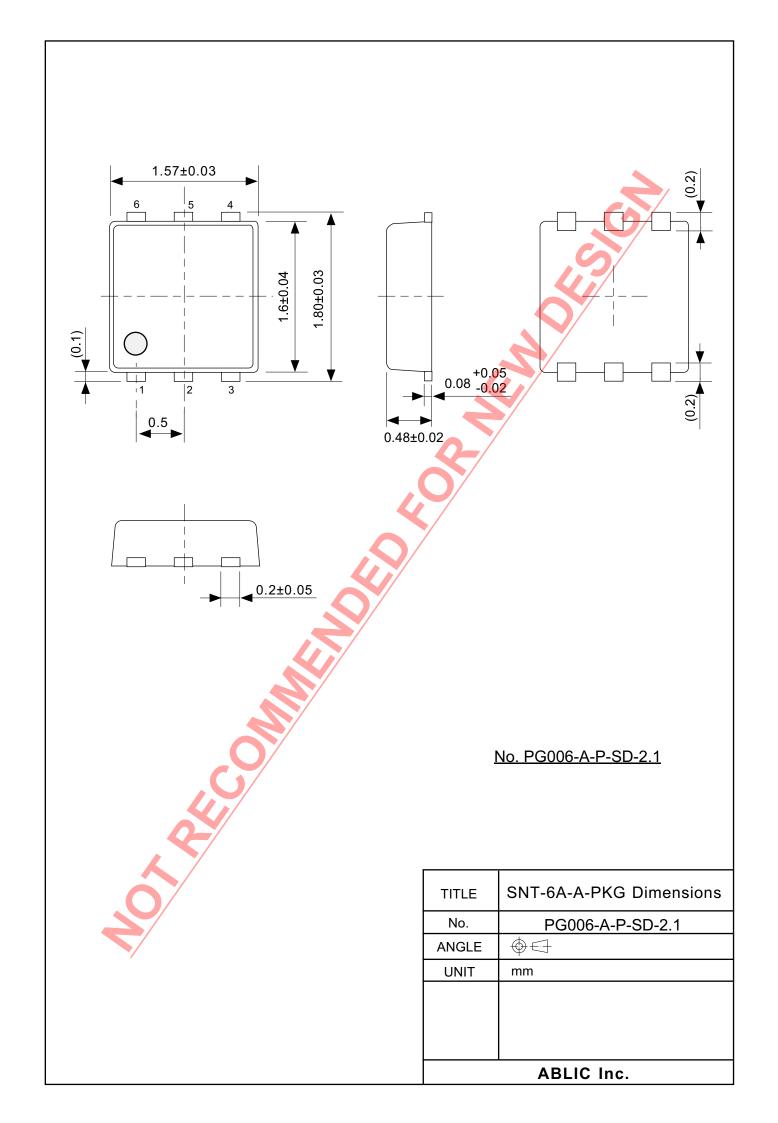
Product name vs. Product code

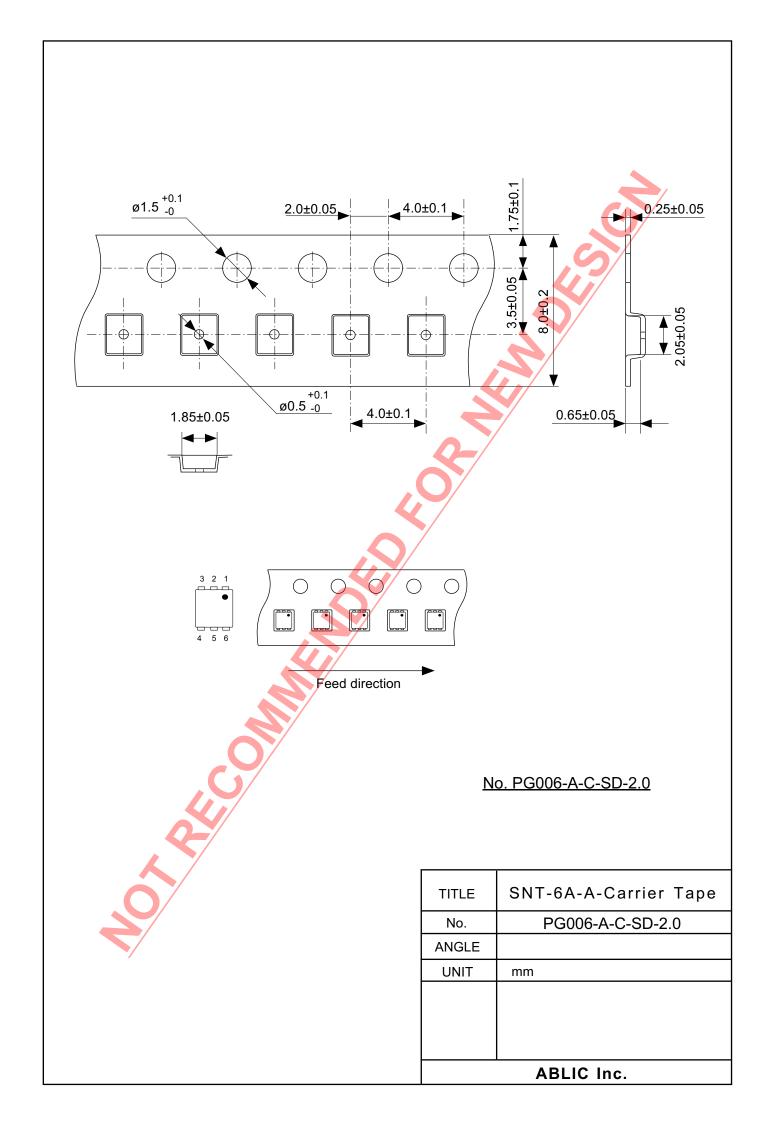
Due do et Neve e	Pro	oduct Co	de
Product Name	(1)	(2)	(3)
S-5842AAAAL-I6T1U	U	- 1	L
S-5842AAAAT-I6T1U	U	I	Т
S-5842ABAAA-I6T1U	U	Н	Α
S-5842ABAAC-I6T1U	U	Н	С
S-5842ABAAJ-I6T1U	U	Н	J
S-5842ABAAP-I6T1U	U	Н	Р
S-5842ABAAV-I6T1U	U	Н	٧
S-5842ABAAW-I6T1U	U	Н	W
S-5842ABAAX-I6T1U	U	Н	X
S-5842ACAAS-I6T1U	U	J	S
S-5842ADAAH-I6T1U	U	G	H
S-5842ADAAK-I6T1U	U	G	K
S-5842ADAAQ-I6T1U	U	G	Q

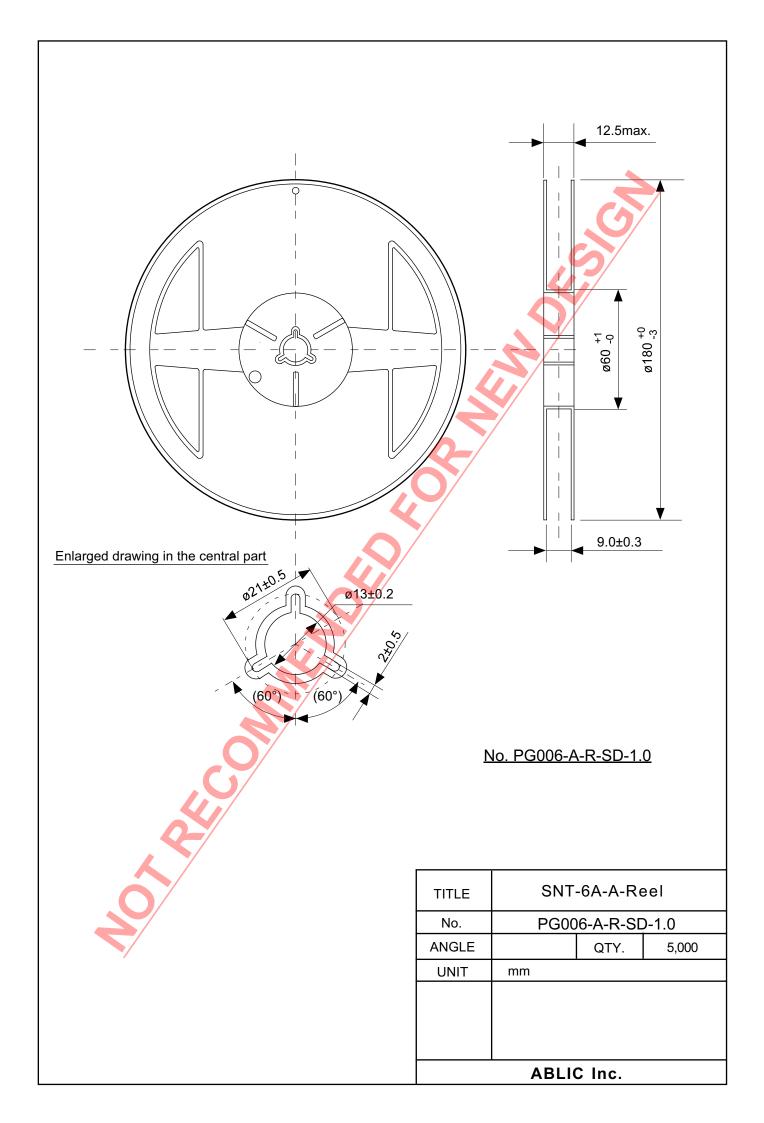


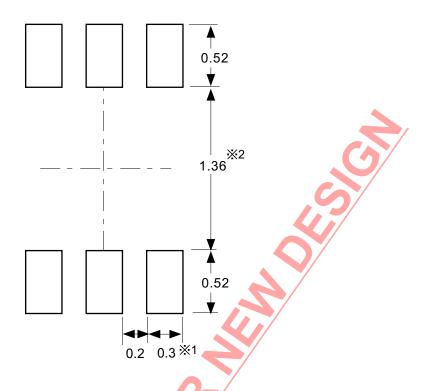












※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 ※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
 - 3. マスク開口サイズと開口位置はランドパターンと合わせてください。
 - 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。
- *1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).
- *2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).
- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
 - 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 - 3. Match the mask aperture size and aperture position with the land pattern.
 - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm ~ 1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
 - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
 - 4. 详细内容请参阅 "SNT 封装的应用指南"。

No. PG006-A-L-SD-4.1

TITLE	SNT-6A-A -Land Recommendation
No.	PG006-A-L-SD-4.1
ANGLE	
UNIT	mm
ARLIC Inc	

ABLIC Inc.

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2.0-2018.01



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